Special Issue

Emerging and New Technologies in Embedded Systems

Message from the Guest Editors

This Special Issue (SI) invites papers on research achievements in emerging and new technologies in embedded systems. Embedded systems have matured as a discriminating technology for a wide variety of applications in our daily life. However, this immense impact is unfortunately confined by the power and cost constraints of hardware devices. A growing gap has been observed between computing demands of modern applications and the availability of hardware resources in embedded systems, thereby raising many unique research challenges and research questions. Recent technologies have evolved tremendously to approach a wide range of applications and implementations that push such limits in the performances of embedded computing. Many novel hardware architectures are deployed for improving the performance of embedded systems, while emerging applications, e.g., deep learning, are implemented on embedded systems to pave the way of ubiquitous AI. In this SI, we look forward to the latest, original research work that suggests new architecture and practical solutions for various applications of embedded systems.

Guest Editors

Dr. Gang Chen

Department of Computer Science, Sun Yat-sen University, Guangzhou 510275, China

Dr. Letian Huang

School of Electronic Science and Engineering, University of Electronic Science and Technology of China, Chengdu 610056, China

Dr. Di Liu

School of Software, Yunnan University, Yunnan 650106, China

Deadline for manuscript submissions

closed (15 June 2023)



Electronics

an Open Access Journal by MDPI

Impact Factor 2.6 CiteScore 6.1



mdpi.com/si/120934

Electronics
Editorial Office
MDPI, Grosspeteranlage 5
4052 Basel, Switzerland
Tel: +41 61 683 77 34
electronics@mdpi.com

mdpi.com/journal/electronics





Electronics

an Open Access Journal by MDPI

Impact Factor 2.6 CiteScore 6.1



About the Journal

Message from the Editor-in-Chief

Electronics is a multidisciplinary journal designed to appeal to a diverse audience of research scientists, practitioners, and developers in academia and industry. The journal is devoted to fast publication of latest technological breakthroughs, cutting-edge developments, and timely reviews of current and emerging technologies related to the broad field of electronics. Experimental and theoretical results are published as regular peer-reviewed articles or as articles within Special Issues guestedited by leading experts in selected topics of interest.

Editor-in-Chief

Prof. Dr. Flavio Canavero

Department of Electronics and Telecommunications, Politecnico di Torino, 10129 Torino, Italy

Author Benefits

High Visibility:

indexed within Scopus, SCIE (Web of Science), CAPlus / SciFinder, Inspec, Ei Compendex and other databases.

Journal Rank:

JCR - Q2 (Engineering, Electrical and Electronic) / CiteScore - Q1 (Electrical and Electronic Engineering)

Rapid Publication:

manuscripts are peer-reviewed and a first decision is provided to authors approximately 16.8 days after submission; acceptance to publication is undertaken in 2.4 days (median values for papers published in this journal in the first half of 2025).

